

TOSHIBA Photocoupler GaAs Ired & Photo-Transistor

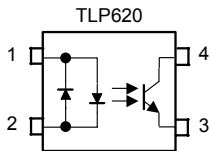
TLP620, TLP620-2, TLP620-4

Programmable Controllers
AC / DC-Input Module
Telecommunication

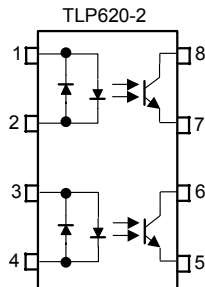
The TOSHIBA TLP620, -2 and -4 consists of a photo-transistor optically coupled to two gallium arsenide infrared emitting diode connected in inverse parallel.
The TLP620-2 offers two isolated channels in an eight lead plastic DIP, while the TLP620-4 provides four isolated channels in a sixteen plastic DIP.

- Collector-emitter voltage: 55V (min.)
- Current transfer ratio: 50% (min.)
Rank GB: 100% (min.)

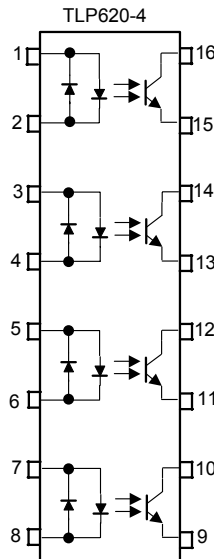
Pin Configurations (top view)



1 : ANODE
CATHODE
2 : CATHODE
ANODE
3 : EMITTER
4 : COLLECTOR

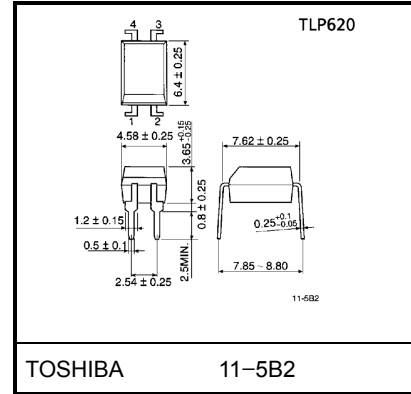


1, 3 : ANODE
CATHODE
2, 4 : CATHODE
ANODE
5, 7 : EMITTER
6, 8 : COLLECTOR

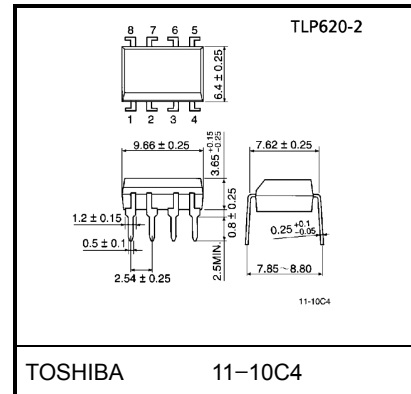


1, 3, 5, 7 : ANODE, CATHODE
2, 4, 6, 8 : CATHODE, ANODE
9, 11, 13, 15 : EMITTER
10, 12, 14, 16 : COLLECTOR

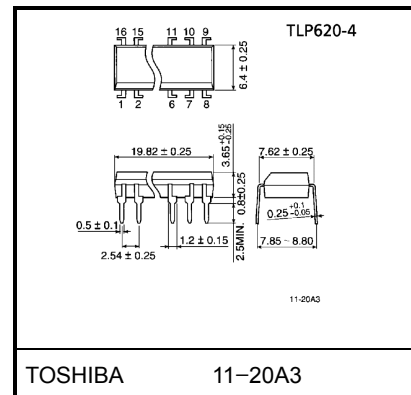
Unit in mm



Weight: 0.26 g



Weight: 0.54 g



Weight: 1.1 g

| | Made In Japan | Made In Thailand |
|---------------|---------------|------------------|
| UL recognized | E67349 *1 | E152349 *1 |
| BSI approved | 7426, 7427 *2 | 7426, 7427 *2 |

*1 UL1577

*2 BS EN60065: 1994, BS EN60950: 1992

- Isolation voltage: 5000V_{rms} (min.)
- Option (D4) type
VDE approved: DIN VDE0884 / 06.92, certificate no. 68384
Maximum operating insulation voltage: 890V_{PK}
Highest permissible over voltage: 8000V_{PK}

(Note) When a VDE0884 approved type is needed, please designate the "Option(D4)".

- Creepage distance: 6.4mm (min.)
Clearance: 6.4mm (min.)
Insulation thickness: 0.4mm (min.)

Maximum Ratings (Ta = 25°C)

| Characteristic | Symbol | Rating | | Unit | |
|---|--|-----------------------------|-------------------------|------------------|---------|
| | | TLP620 | TLP620-2 TLP620-4 | | |
| LED | Forward current | I _F (RMS) | 60 | 50 | mA |
| | Forward current derating | ΔI _F / °C | -0.7 (Ta ≥ 39°C) | -0.5 (Ta ≥ 25°C) | mA / °C |
| | Pulse forward current | I _{FP} | 1 (100μs pulse, 100pps) | | A |
| | Power dissipation (1 circuit) | P _D | 100 | 70 | mW |
| | Power dissipation derating | ΔP _D / °C | -1.0 | -0.7 | mW / °C |
| | Junction temperature | T _j | 125 | | °C |
| Detector | Collector-emitter voltage | V _{CEO} | 55 | | V |
| | Emitter-collector voltage | V _{ECO} | 7 | | V |
| | Collector current | I _C | 50 | | mA |
| | Collector power dissipation (1 circuit) | P _C | 150 | 100 | mW |
| | Collector power dissipation derating (1 circuit) (Ta ≥ 25°C) | ΔP _C / °C | -1.5 | -1.0 | mW / °C |
| | Junction temperature | T _j | 125 | | °C |
| Storage temperature range | T _{stg} | -55~125 | | °C | |
| Operating temperature range | T _{opr} | -55~100 | | °C | |
| Lead soldering temperature | T _{sold} | 260 (10s) | | °C | |
| Total package power dissipation | P _T | 250 | 150 | mW | |
| Total package power dissipation derating (Ta ≥ 25°C, 1 circuit) | ΔP _T / °C | -2.5 | -1.5 | mW / °C | |
| Isolation voltage | BV _S | 5000 (AC, 1 min., RH ≤ 60%) | | V _{rms} | |

Recommended Operating Conditions

| Characteristic | Symbol | Min. | Typ. | Max. | Unit |
|-----------------------|-------------|------|------|------|------|
| Supply voltage | V_{CC} | — | 5 | 24 | V |
| Forward current | I_F (RMS) | — | 16 | 20 | mA |
| Collector current | I_C | — | 1 | 10 | mA |
| Operating temperature | T_{opr} | -25 | — | 85 | °C |

Individual Electrical Characteristics ($T_a = 25^\circ\text{C}$)

| Characteristic | | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|------------------------------------|-------------------------------------|-------------------------------|---|------|------|------|---------------|
| LED | Forward voltage | V_F | $I_F = \pm 10\text{mA}$ | 1.0 | 1.15 | 1.3 | V |
| | Forward current | I_F | $V_F = \pm 0.7\text{V}$ | — | 2.5 | 20 | μA |
| | Capacitance | C_T | $V = 0, f = 1\text{MHz}$ | — | 60 | — | pF |
| Detector | Collector-emitter breakdown voltage | $V_{(BR)CEO}$ | $I_C = 0.5\text{mA}$ | 55 | — | — | V |
| | Emitter-collector breakdown voltage | $V_{(BR)ECO}$ | $I_E = 0.1\text{mA}$ | 7 | — | — | V |
| | Collector dark current | I_{CEO} | $V_{CE} = 24\text{V}$ | — | 10 | 100 | nA |
| | | | $V_{CE} = 24\text{V}, T_a = 85^\circ\text{C}$ | — | 2 | 50 | μA |
| Capacitance (collector to emitter) | C_{CE} | $V_{CE} = 0, f = 1\text{MHz}$ | — | 10 | — | pF | |

Coupled Electrical Characteristics ($T_a = 25^\circ\text{C}$)

| Characteristic | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|--------------------------------------|-------------------|---|------|------|------|---------------|
| Current transfer ratio | I_C / I_F | $I_F = \pm 5\text{mA}, V_{CE} = 5\text{V}$ Rank GB | 50 | — | 600 | % |
| | | | 100 | — | 600 | |
| Saturated CTR | I_C / I_F (sat) | $I_F = \pm 1\text{mA}, V_{CE} = 0.4\text{V}$ Rank GB | — | 60 | — | % |
| | | | 30 | — | — | |
| Collector-emitter saturation voltage | V_{CE} (sat) | $I_C = 2.4\text{mA}, I_F = \pm 8\text{mA}$ | — | — | 0.4 | V |
| | | $I_C = 0.2\text{mA}, I_F = \pm 1\text{mA}$ Rank GB | — | 0.2 | — | |
| | | — | — | 0.4 | | |
| Off-state collector current | I_C (off) | $V_F = \pm 0.7\text{V}, V_{CE} = 24\text{V}$ | — | 1 | 10 | μA |
| CTR symmetry | I_C (ratio) | $I_C (I_F = -5\text{mA}) / I_C (I_F = +5\text{mA})$ | 0.33 | 1 | 3 | — |

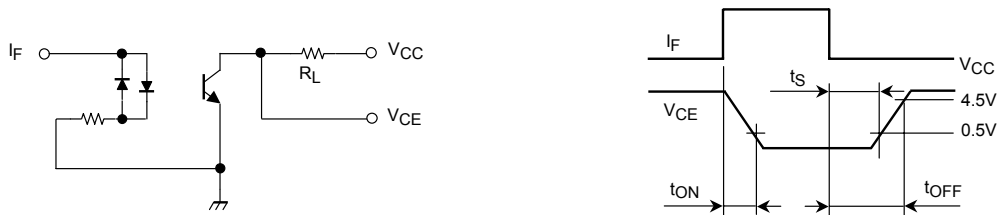
Isolation Characteristics (Ta = 25°C)

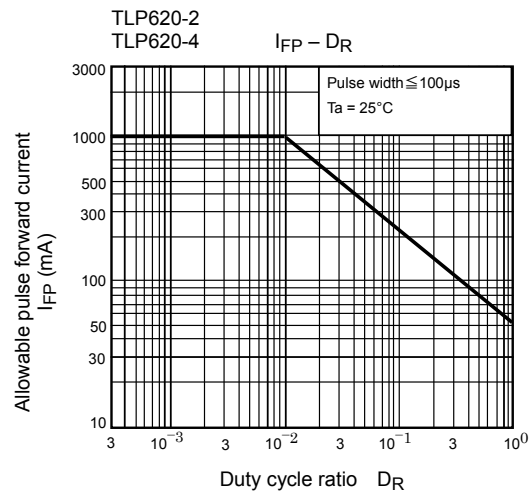
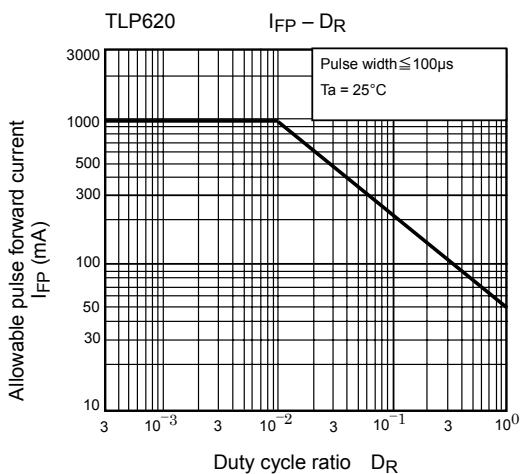
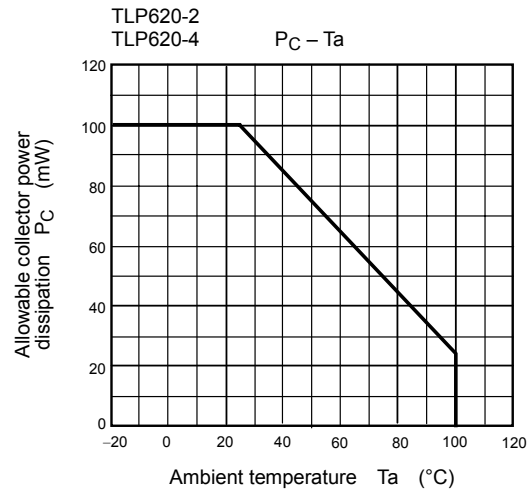
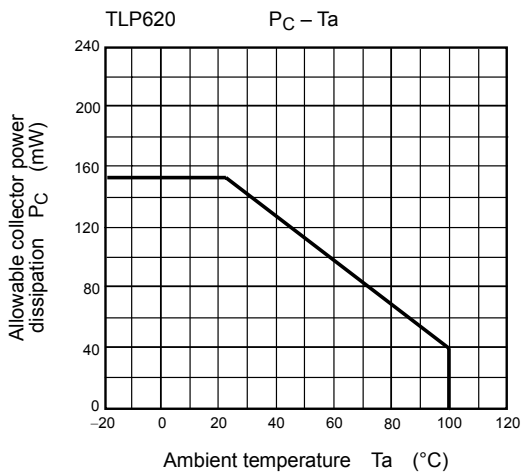
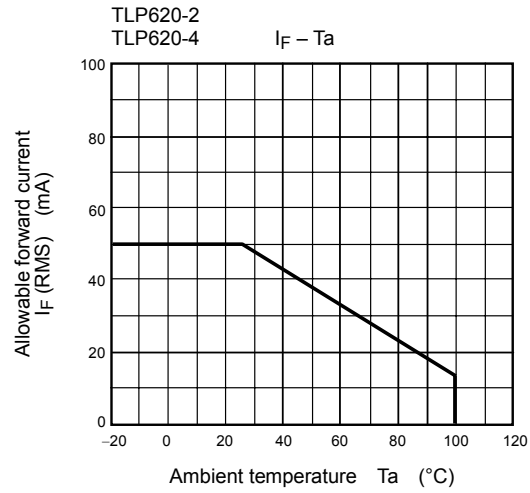
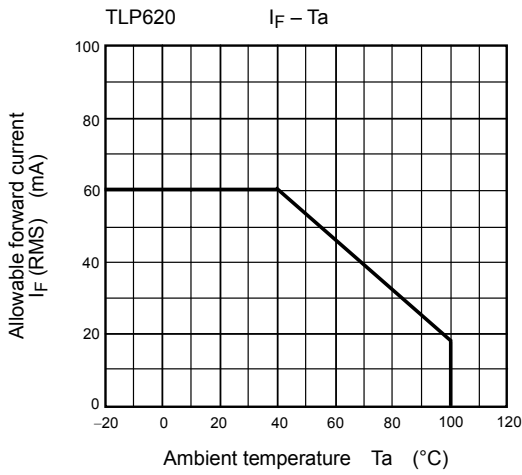
| Characteristic | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|-----------------------------|-----------------|------------------------------|--------------------|------------------|------|------------------|
| Capacitance input to output | C _S | V _S = 0, f = 1MHz | — | 0.8 | — | pF |
| Isolation resistance | R _S | V _S = 500V | 1×10 ¹² | 10 ¹⁴ | — | Ω |
| Isolation voltage | BV _S | AC, 1 minute | 5000 | — | — | V _{rms} |
| | | AC, 1 second, in oil | — | 10000 | — | |
| | | DC, 1 minute, in oil | — | 10000 | — | V _{dc} |

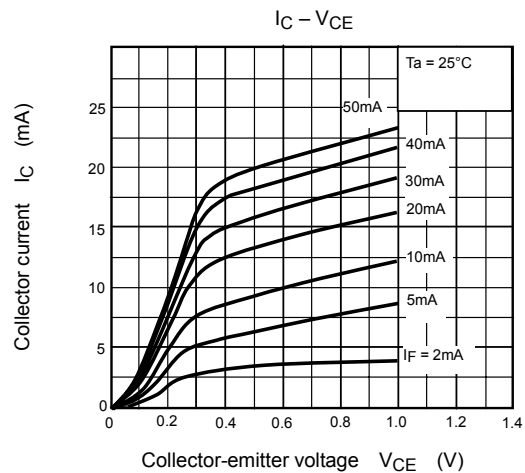
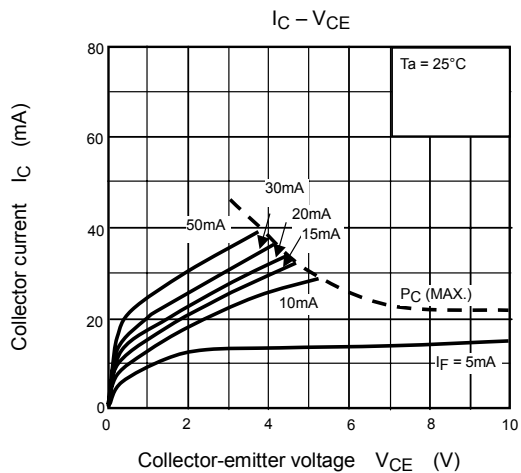
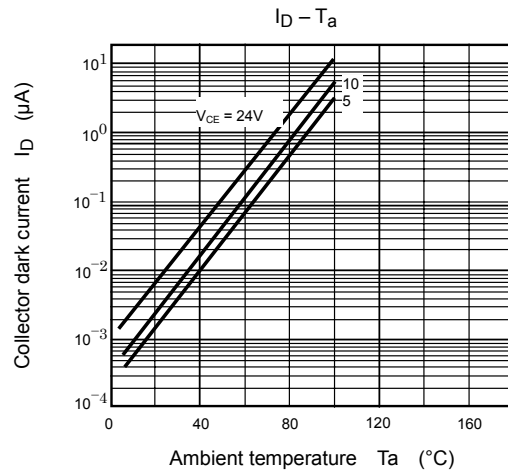
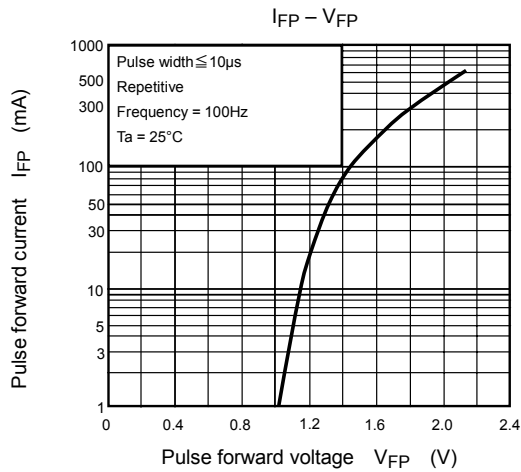
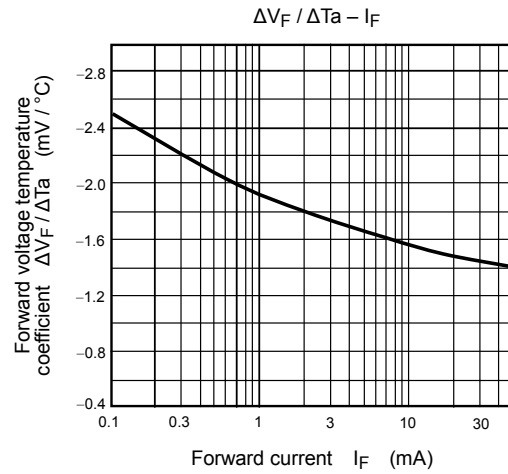
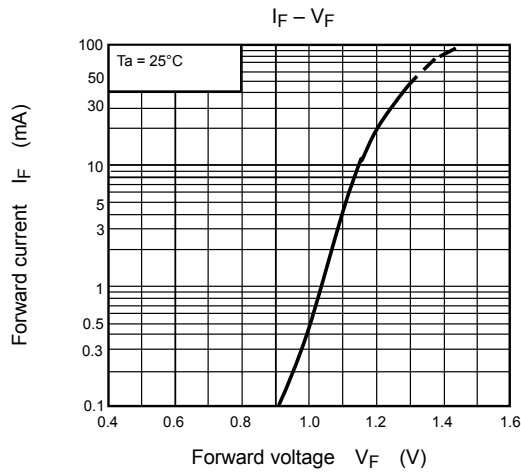
Switching Characteristics (Ta = 25°C)

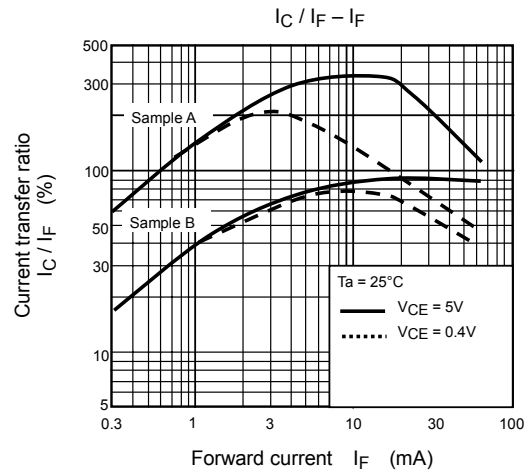
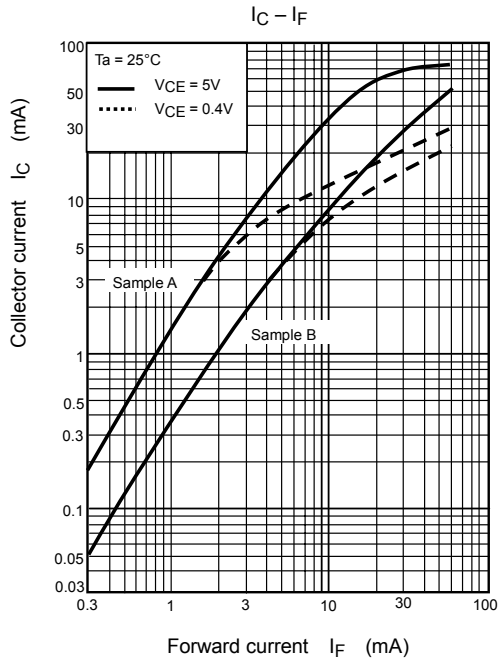
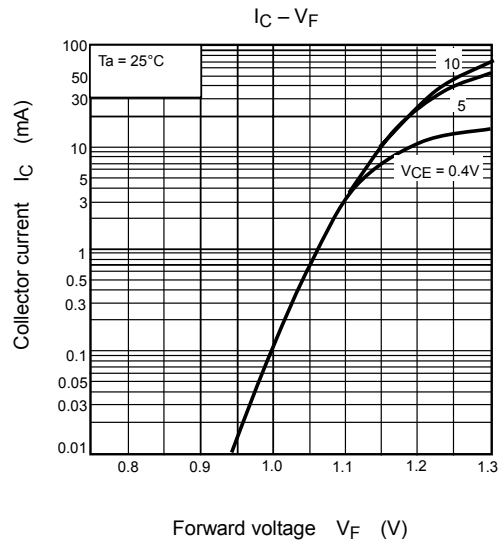
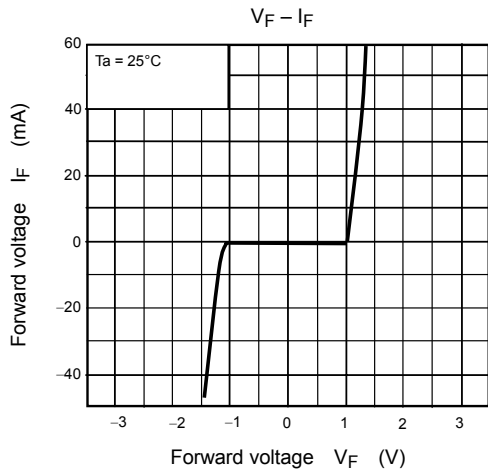
| Characteristic | Symbol | Test Condition | Min. | Typ. | Max. | Unit |
|----------------|------------------|---|------|------|------|------|
| Rise time | t _r | V _{CC} = 10V I _C = 2mA R _L = 100Ω | — | 2 | — | μs |
| Fall time | t _f | | — | 3 | — | |
| Turn-on time | t _{on} | | — | 3 | — | |
| Turn-off time | t _{off} | | — | 3 | — | |
| Turn-on time | t _{ON} | R _L = 1.9kΩ V _{CC} = 5V, I _F = ±16mA (Fig.1) | — | 2 | — | μs |
| Storage time | t _s | | — | 15 | — | |
| Turn-off time | t _{OFF} | | — | 25 | — | |

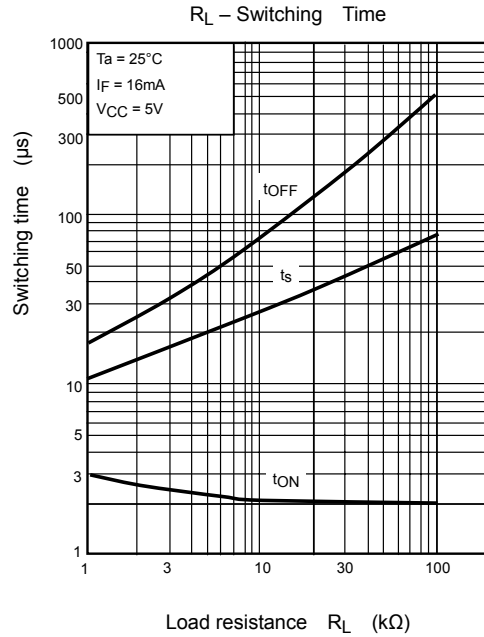
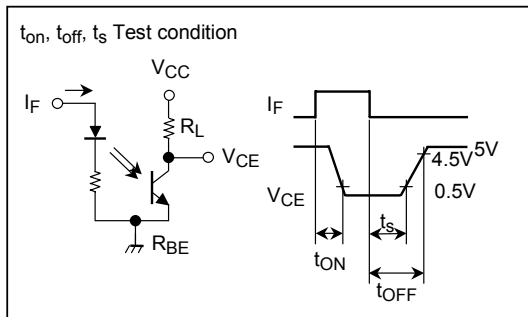
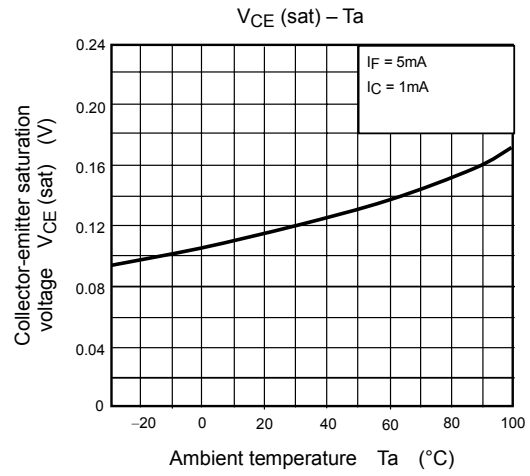
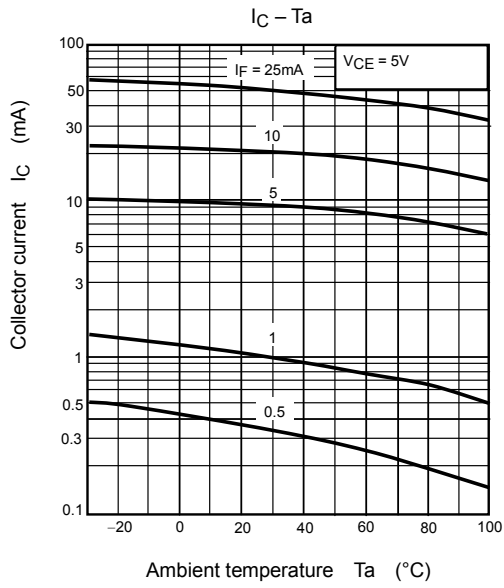
Fig. 1 Switching time test circuit











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000707EBC

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